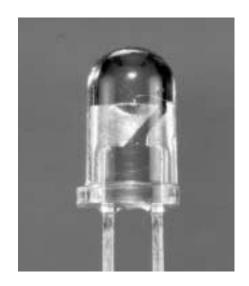
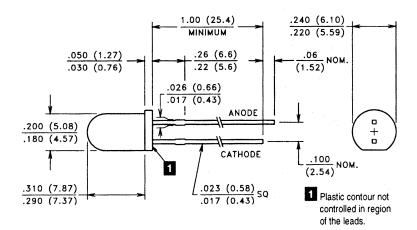
GaAlAs Infrared Emitting Diodes

T-1¾ (5 mm) Plastic Package — 880 nm

VTE1291W-1H, W-2H



PACKAGE DIMENSIONS inch (mm)



DESCRIPTION

CASE 26W T-1¾ (5 mm) WIDE ANGLE CHIP SIZE: .015" x .015"

This wide beam angle 5 mm plastic packaged emitter contains a double wirebonded, GaAlAs, 880 nm IRED chip. This cost effective design is well suited for dc or high current pulse applications. This device is a UL recognized component for smoke alarm applications (UL file #S3506).

RoHS Compliant

ABSOLUTE MAXIMUM RATINGS @ 25°C (unless otherwise noted) ■

Maximum Temperatures Storage and Operating:	-40°C to 100°C	Maximum Reverse Voltage: Maximum Reverse Current @ V _R = 5V:	5.0V 10 μA
Continuous Power Dissipation:	200 mW	Peak Wavelength (Typical):	880 nm
Derate above 30°C:	2.86 mW/°C	Junction Capacitance @ 0V, 1 MHz (Typ.):	23 pF
Maximum Continuous Current:	100 mA	Response Time @ I _F = 20 mA	
Derate above 30°C:	1.43 mA/°C	Rise: 1.0 μs Fall: 1.0 μs	
Peak Forward Current, 10 µs, 100 pps:	2.5 A	Lead Soldering Temperature:	260°C
Temp. Coefficient of Power Output (Typ.):	8%/°C	(1.6 mm from case, 5 seconds max.)	

ELECTRO-OPTICAL CHARACTERISTICS @ 25°C (See also GaAlAs curves, pages 108-110)

Part Number	Output						Forward Drop		Half Power Beam	
	Irradiance			Radiant Intensity	Total Power	Test Current	V _F		Angle	
	E _e Cond		dition	I _e	P _O	I _{FT}	@	I _{FT}	θ _{1/2}	
	mW/cm ²		distance	Diameter	mW/sr	mW	mA	Volts		Тур.
	Min.	Тур.	mm	mm	Min.	Тур.	(Pulsed)	Тур.	Max.	ıyp.
VTE1291W-1H	1.2	1.6	36	6.4	16	20	100	1.5	2.0	±25°
VTE1291W-2H	2.5	3.3	36	6.4	32	25	100	1.5	2.0	±25°

■ Refer to General Product Notes, page 2.